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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT(s): VILLEFRANCE, et al.

SERIAL NO.: 10/606,385

ART UNIT:

FILING DATE: 6/26/03

EXAMINER:

TITLE: METHOD AND SYSTEM ESTABLISHING A DATA LINK
LAYER PROTOCOL ON A I2CTM PHYSICAL LAYER
CONNECTION

ATTORNEY

DOCKET NO.: 684-011395-US (PAR)

Commissioner of Patents
P.O. Box 1450
Alexandria, VA 22313-1450

INFORMATION DISCLOSURE STATEMENT
(37 C.F.R. §1.97(b)(3))

Sir:

This information disclosure statement is being filed before the mailing of a first Office Action on the merits.

The following information is being disclosed to the Patent and Trademark Office as information that may be material to the examination of the above-identified patent application. Applicants' Attorney is aware of the following references:

US 6,134,665

"Internet Connectivity: Stacking the Odds in Your Favor", Jack G. Ganssle, Embedded Systems Programming, 1998, pages 34-42

"Consultative Committee for Space Data Systems, Draft Recommendation for Space Data System Standards", Red Book, 2002, pages i-C-3

"The Data Link Layer", XP-002271205, 1996, pages 175-242

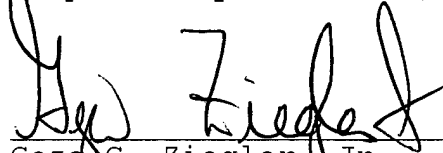
"The I²C-Bus Specification", Version 2.1, 2000, pages 1-46

Copies of these references are enclosed together with a Form PTO-1449.

The filing of this Statement is not to be construed as a representation that a search has been made regarding the claimed invention (37 C.F.R. §1.97(g)) or that no other possible material information exists. In addition, the filing of this Information Disclosure Statement is not to be construed to be an admission that the information cited in the Statement is, or is considered to be, material to patentability (37 C.F.R. §1.97(h)).

The Commissioner is hereby authorized to charge payment for any fees associated with this communication or credit any over payment to Deposit Account No. 16-1350.

Respectfully submitted,



Geza C. Ziegler, Jr.
Reg. No. 44,004

7 Feb 2005
Date

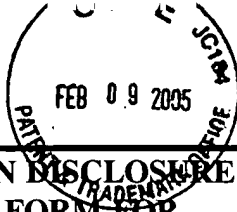
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CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service on the date indicated below as first class mail in an envelope address to the Commissioner of Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

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**INFORMATION DISCLOSURE
CITATION FORM FOR
PATENT APPLICATION
(FORM PTO-1449)
(Substitute)**

Docket No.:

Serial No.:

Applicant(s):

Filing Date:

Group:

U.S. PATENTS

Initials	Patent Number	Issue Date	Name	Class	Sub-class	Filing date
	6,134,665	10/17/00	Klein et al.	713	300	1/20/98

U.S. PATENT PUBLICATIONS

Initials	Publication No.	Pub. Date	Name	Class	Sub-class	Filing Date

FOREIGN PATENT DOCUMENTS

Initials	Document Number	Date	Country	Name	Translation? Yes/No/n/a

OTHER DOCUMENTS (Title, Author, Date, Pages, Etc., if known)

	"Internet Connectivity: Stacking the Odds in Your Favor", EMBEDDED SYSTEMS PROGRAMMING, Jack G. Ganssle, January 1998 (1998-01), pages 34-42, XP008036396
	"Encapsulation Service", CONSULTATIVE COMMITTEE FOR SPACE DATA SYSTEMS, CCSDS 133.1-R-1, (Online) April 2002 (2002-04), pages 1-32, XP002300031 Retrived from the Internet: URL: http://ssdoo.gsfc.nasa.gov/nost/wwwcla/ssic/rpa210/CCSDS-133.1-R-1.pdf
	"Computer Networks, THE DATA LINK LAYER", COMPUTER NETWORKS, LONDON:PRENTICE-HALL INTERNATIONAL, GB, 1996, pages 175-242, XP002271205 ISBN: 0-13-394248-1
	"The I2C-bus specification Version 2.1" PHILIPS SEMICONDUCTORS. PRODUCT SPECIFICATION, XX, XX, January 2000 (2000-01), pages 1-46, XP002218697

Examiner's Signature:

Date Considered:

Initial if reference was considered, whether or not citation is in conformance with MPEP. Mark through citation if not considered.
Include a copy of this citation form with your next correspondence to the Applicant(s).